

Final Product Change Notification

Issue Date:23-Sep-2016Effective Date:05-Jan-2017

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201606013F01



QUALITY

Change Category

| [X] Wafer Fab | [] Assembly | [] Product Marking | [] Test | [] Design | | | | | | |
|---|-------------|-----------------------------|----------------|--------------------------|--|--|--|--|--|--|
| Process | Process | | Location | | | | | | | |
| [X] Wafer Fab | [] Assembly | [] Mechanical Specification | []Test Process | s [] Errata | | | | | | |
| Materials | Materials | | | | | | | | | |
| []Wafer Fab | [] Assembly | [] | [] Test | [] Electrical spec./Test | | | | | | |
| Location | Location | Packing/Shipping/Labeling | Equipment | coverage | | | | | | |
| Release of 8 inch wafer diameter for general purpose diodes | | | | | | | | | | |
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Details of this Change

Release of production using 8 inch wafer diameter for general purpose diodes in SOD323 (SC-76) and SOT23 packages. In addition a 2nd source epitaxy supplier will be introduced. The top metallization thickness of the affected diodes will be adapted.

Old products: Production using 6 inch wafer diameter, inhouse epitaxy, top side metallization thickness 1.4µm

Changed products: Production using 8 inch wafer diameter, inhouse epitaxy or external epitaxy supplier, top side metallization thickness 1.5µm

Production on 8 inch wafer diameter implies the use of the respective 8 inch wafer process technology. Why do we Implement this Change

To increase flexibility and volume ramp-up.

Identification of Affected Products

The 8 inch products can be identified by a marker on the die surface.

Product Availability

Sample Information

Samples are available upon request Latest sample request date for PCN samples is 23-Oct-2016. **Production** Planned first shipment 09-Jan-2017 Impact

No impact to the products' functionality anticipated.

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 23-Oct-2016.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly: Name GA Customer Support DiscrQA.Helpdesk.GA-Products@nxp.com e-mail address

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NXP Quality Management Team. **About NXP Semiconductors**

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| Changed Orderable Part# | Changed Part 12NC | Changed Part Number | Changed Part Description | Package Outline | Package Name | Status | Product Line |
|-------------------------|-------------------|---------------------|--------------------------|-----------------|--------------|--------|------------------------|
| BAS21,215 | 933502040215 | BAS21 | Switching diode | SOT23 | TO-236AB | RFS | BL GA DISCRETES |
| BAV23C,215 | 934061767215 | BAV23C | Switching Diode | SOT23 | TO-236AB | RFS | BL GA DISCRETES |
| BAS19,215 | 933502020215 | BAS19 | Switching diode | SOT23 | TO-236AB | RFS | BL GA DISCRETES |
| BAS321,115 | 934055352115 | BAS321 | Switching diode | SOD323 | SOD2 | RFS | BL GA DISCRETES |
| BAS21,235 | 933502040235 | BAS21 | Switching diode | SOT23 | TO-236AB | RFS | BL GA DISCRETES |
| BAV23A,215 | 934061766215 | BAV23A | Switching Diode | SOT23 | TO-236AB | RFS | BL GA DISCRETES |
| BAV23S,215 | 933947770215 | BAV23S | Switching diode | SOT23 | TO-236AB | RFS | BL GA DISCRETES |
| BAS20,215 | 933502030215 | BAS20 | Switching diode | SOT23 | TO-236AB | RFS | BL GA DISCRETES |